

MOS FIELD EFFECT TRANSISTORS 2SK2367/2SK2368

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK2367/2SK2368 is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

FEATURES

· Low On-Resistance

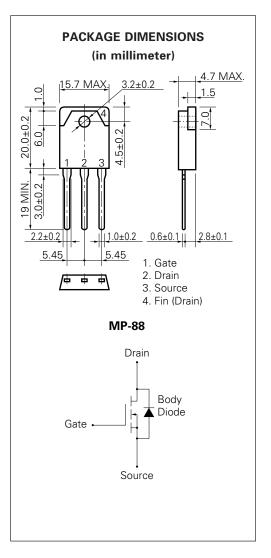
2SK2367: RDS (on) = 0.5 Ω (VGS = 10 V, ID = 8.0 A) 2SK2368: RDS (on) = 0.6 Ω (VGS = 10 V, ID = 8.0 A)

- Low Ciss Ciss = 1 600 pF TYP.
- High Avalanche Capability Ratings

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage (2SK2367/2SK2368)	Voss	450/500	V
Gate to Source Voltage	Vgss	±30	V
Drain Current (DC)	ID (DC)	±15	Α
Drain Current (pulse)*	ID (pulse)	±60	Α
Total Power Dissipation ($T_c = 25$ °C)	P _{T1}	120	W
Total Power Dissipation (T _A = 25 °C)	P _{T2}	3.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	T _{stg} -	55 to +150	°C
Single Avalanche Current**	las	15	Α
Single Avalanche Energy**	Eas	161	mJ

- * PW \leq 10 μ s, Duty Cycle \leq 1 %
- ** Starting T_{ch} = 25 °C, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0



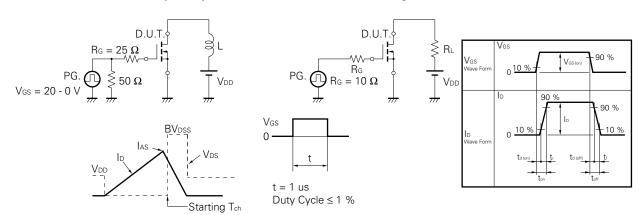


ELECTRICAL CHARACTERISTICS (TA = 25 °C)

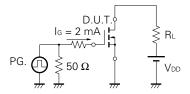
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS	
Drain to Source On-Resistance	RDS (on)		0.4	0.5	Ω	V _{GS} = 10 V	2SK2367
			0.5	0.6		ID = 8.0 A	2SK2368
Gate to Source Cutoff Voltage	VGS (off)	2.5		3.5	V	V _{DS} = 10 V, I	D = 1 mA
Forward Transfer Admittance	yfs	5.0			S	VDS = 10 V, ID = 8.0 A	
Drain Leakage Current	IDSS			100	μΑ	VDS = VDSS, V	'gs = 0
Gate to Source Leakage Current	Igss			±100	nA	$V_{GS} = \pm 30 \text{ V},$	V _{DS} = 0
Input Capacitance	Ciss		1 600		pF	V _{DS} = 10 V	
Output Capacitance	Coss		300		pF	V _G S = 0	
Reverse Transfer Capacitance	Crss		30		pF	f = 1 MHz	
Turn-On Delay Time	td (on)		30		ns	ID = 8.0 A	
Rise Time	tr		40		ns	V _{GS} = 10 V	
Turn-Off Delay Time	td (off)		70		ns	VDD = 150 V	
Fall Time	tf		25		ns	$R_G = 10 \Omega R_L = 18.8 \Omega$	
Total Gate Charge	QG		43		nC	ID = 15 A	
Gate to Source Charge	Qgs		10		nC	V _{DD} = 400 V	
Gate to Drain Charge	Q _{GD}		20		nC	V _{GS} = 10 V	
Body Diode Forward Voltage	V _F (S-D)		1.0		V	IF = 15 A, VG	s = 0
Reverse Recovery Time	trr		400		ns	IF = 15 A, VG	s = 0
Reverse Recovery Charge	Qrr		1.8		μC	di/dt = 50 A/	μs

Test Circuit 1 Avalanche Capability

Test Circuit 2 Switching Time

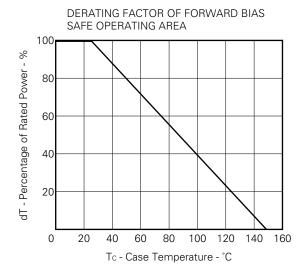


Test Circuit 3 Gate Charge

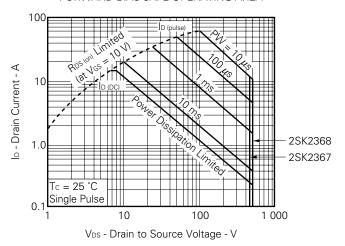


The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

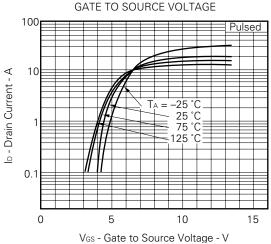
TYPICAL CHARACTERISTICS (TA = 25 °C)

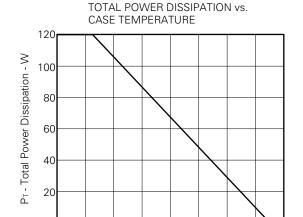


FORWARD BIAS SAFE OPERATING AREA



DRAIN CURRENT vs.





DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

80

Tc - Case Temperature - °C

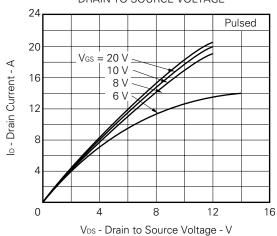
100 120

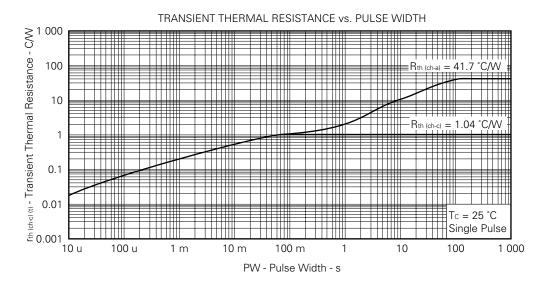
140 160

0

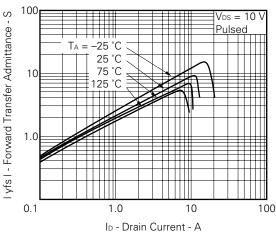
20

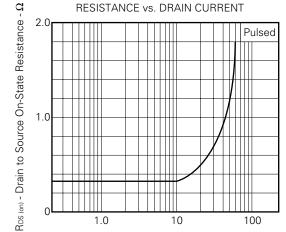
40











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ID - Drain Current - A

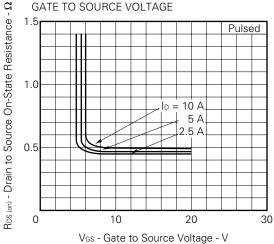
100

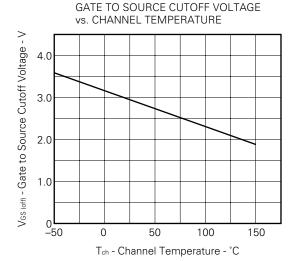
1.0

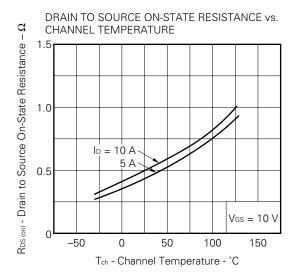
DRAIN TO SOURCE ON-STATE

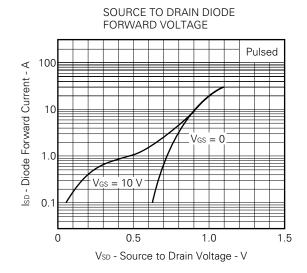
RESISTANCE vs. DRAIN CURRENT

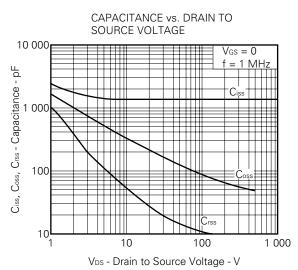
DRAIN TO SOURCE ON-STATE RESISTANCE vs. **GATE TO SOURCE VOLTAGE**

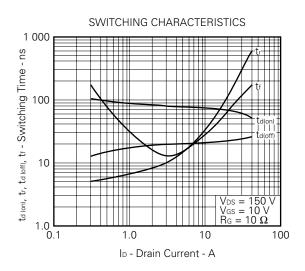


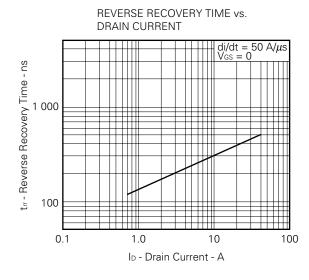


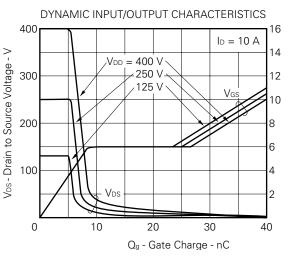






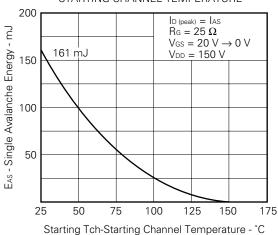




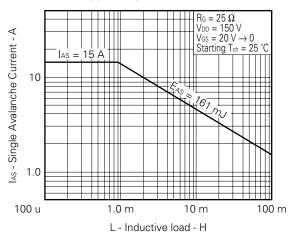




SINGLE AVALANCHE ENERGY vs. STARTING CHANNEL TEMPERATURE



SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD



REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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Anti-radioactive design is not implemented in this product.